

# Product Specification

(Preliminary)

**Part Name:** Monochrome LCD Display Module

**Part No.:** BCG1602-04 SERIES

**Doc No.:** SAS1-1710-A

**Customer:**

Approved by:

**From:** Blaze Display Technology Co., Ltd.

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2. The information contained herein is presented merely to indicate the characteristics and performance of our products. No responsibility is assumed by Blaze Display Technology Co., Ltd. for any intellectual property claims or other problems that may result application based on the module described herein.

*Revised History*

Part Number	Revision	Revision Content	Revised on
BCG1602-04-NN-FPRWU-1.0	1.0	New	Feb 06th, 2017
<b>CONFIDENTIAL</b>			



# CONFIDENTIAL

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## **1. Basic Specifications**

### **1.1 Display Specifications**

- |                           |                         |
|---------------------------|-------------------------|
| 1) Display Type:          | FSTN(B/W)/ Positive     |
| 2) Display Format:        | 16 Characters × 2 Lines |
| 3) Character Color (ON):  | Black                   |
| 4) Background Color (ON): | Gray                    |
| Background Color (OFF):   | Gray                    |
| 5) Drive Method:          | 1/16 Duty; 1/5Bias      |
| 6) Viewing Direction:     | 12:00                   |
| 7) Polarizer Type:        | Reflective              |

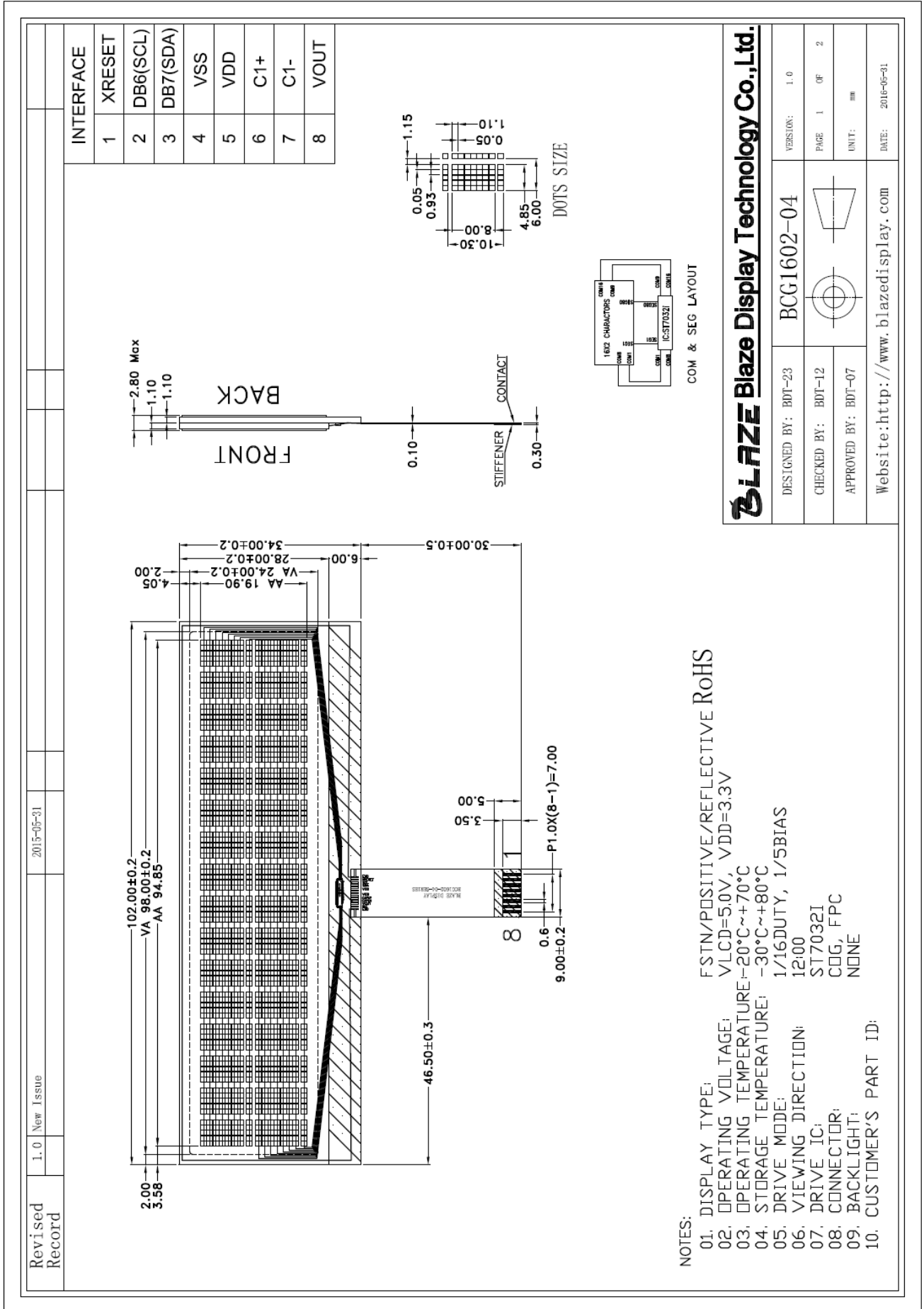
### **1.2 Mechanical Specifications**

- |                        |   |
|------------------------|---|
| 1) Outline Dimensions: | According to the annexed outline drawing on the next page |
| 2) Viewing Area:       | 98.00 W × 24.00 H (mm)                                    |
| 3) Active Area:        | 94.85 W × 19.90 H (mm)                                    |
| 4) Dot Pitch:          | 0.98W × 1.15 H (mm)                                       |
| 5) Dot Size:           | 0.93W × 1.10 H (mm)                                       |
| 6) Weight:             | T.B.D.  |

### **1.3 Others**

- |                           |               |
|---------------------------|---------------|
| 1) Driver IC:             | ST7032I       |
| 2) Backlight:             | NONE          |
| 3) Operating Temperature: | -20°C— + 70°C |
| 4) Storage Temperature:   | -30°C— + 80°C |
| 5) RoHS Compliant:        | Yes           |

1.4 Mechanical Drawing



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DESIGNED BY: BDT-23      BCG1602-04      VERSION: 1.0

CHECKED BY: BDT-12           PAGE 1 OF 2

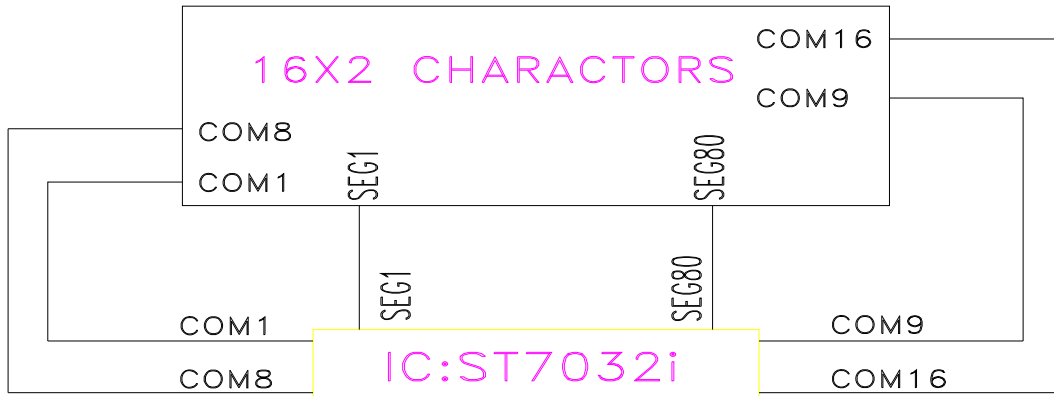
APPROVED BY: BDT-07           UNIT: mm

Website: <http://www.blazedisplay.com>      DATE: 2016-05-31

- NOTES:
1. DISPLAY TYPE: FSTN/POSITIVE/REFLECTIVE RoHS
  2. OPERATING VOLTAGE: VLCD=5.0V, VDD=3.3V
  3. OPERATING TEMPERATURE: -20°C~+70°C
  4. STORAGE TEMPERATURE: -30°C~+80°C
  5. DRIVE MODE: 1/16DUTY, 1/5BIAS
  6. VIEWING DIRECTION: 12:00
  7. DRIVE IC: ST7032I
  8. CONNECTOR: COG, FPC
  9. BACKLIGHT: NONE
  10. CUSTOMER'S PART ID:

## 2. Electrical Specification

### 2.1 Block Diagram



## COM & SEG LAYOUT

Character located	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
DDRAMAddress	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
DDRAMAddress	40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F

### 2.2 Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit
Power Supply for Logic	Vdd	-0.3	+6.0	V
Power supply for LCD Drive	Vlcd	Vss + 0.3	Vss + 5.0	V
Input Voltage	Vin	-0.3	Vdd + 0.3	V
Operating Temperature	Topr	-20	+70	°C
Storage Temperature	Tstg	-30	+80	°C

### 2.3 Electrical Characteristics

Ta = 25°C; Vdd = 5.0V, otherwise specified

( TA = -30°C to 85°C, VDD = 2.7 V – 4.5 V )

Symbol	Characteristics	Test Condition	Min.	Typ.	Max.	Unit
VDD	Operating Voltage	-	2.7	-	4.5	V
V <sub>LCD</sub>	LCD Voltage	V0-Vss	2.7	-	7.0	V
I <sub>CC</sub>	Power Supply Current	VDD=3.0V (Use internal booster/follower circuit)	-	160	230	uA
V <sub>IH1</sub>	Input High Voltage (Except OSC1)	-	1.9	-	VDD	V
V <sub>IL1</sub>	Input Low Voltage (Except OSC1)	-	- 0.3	-	0.8	V
V <sub>IH2</sub>	Input High Voltage (OSC1)	-	0.7 VDD	-	VDD	V
V <sub>IL2</sub>	Input Low Voltage (OSC1)	-	-	-	0.2 VDD	V
V <sub>OH1</sub>	Output High Voltage (DB0 - DB7)	I <sub>OH</sub> = -1.0mA	0.75 VDD	-	-	V
V <sub>OL1</sub>	Output Low Voltage (DB0 - DB7)	I <sub>OL</sub> = 1.0mA	-	-	0.8	V
V <sub>OH2</sub>	Output High Voltage (Except DB0 - DB7)	I <sub>OH</sub> = -0.04mA	0.8 VDD	-	VDD	V
V <sub>OL2</sub>	Output Low Voltage (Except DB0 - DB7)	I <sub>OL</sub> = 0.04mA	-	-	0.2 VDD	V
R <sub>COM</sub>	Common Resistance	V <sub>LCD</sub> = 4V, I <sub>d</sub> = 0.05mA	-	2	20	KΩ
R <sub>SEG</sub>	Segment Resistance	V <sub>LCD</sub> = 4V, I <sub>d</sub> = 0.05mA	-	2	30	KΩ
I <sub>LEAK</sub>	Input Leakage Current	V <sub>IN</sub> = 0V to VDD	-1	-	1	μA
I <sub>PUP</sub>	Pull Up MOS Current	VDD = 3V	20	30	40	μA
f <sub>OSC</sub>	Oscillation frequency	VDD = 3V, 1/17duty	350	540	1100	KHz





( TA = -30°C to 85°C, VDD = 4.5 V - 5.5 V )

Symbol	Characteristics	Test Condition	Min.	Typ.	Max.	Unit
VDD	Operating Voltage	-	4.5	-	5.5	V
V <sub>LCD</sub>	LCD Voltage	V <sub>0</sub> -V <sub>SS</sub>	2.7	-	7.0	V
I <sub>CC</sub>	Power Supply Current	VDD=5.0V (Use internal booster/follower circuit)	-	240	340	uA
V <sub>IH1</sub>	Input High Voltage (Except OSC1)	-	2.7	-	VDD	V
V <sub>IL1</sub>	Input Low Voltage (Except OSC1)	-	-0.3	-	0.8	V
V <sub>IH2</sub>	Input High Voltage (OSC1)	-	0.7 VDD	-	VDD	V
V <sub>IL2</sub>	Input Low Voltage (OSC1)	-	-	-	1.0	V
V <sub>OH1</sub>	Output High Voltage (DB0 - DB7)	I <sub>OH</sub> = -1.0mA	3.8	-	VDD	V
V <sub>OL1</sub>	Output Low Voltage (DB0 - DB7)	I <sub>OL</sub> = 1.0mA	-	-	0.8	V
V <sub>OH2</sub>	Output High Voltage (Except DB0 - DB7)	I <sub>OH</sub> = -0.04mA	0.8 VDD	-	VDD	V
V <sub>OL2</sub>	Output Low Voltage (Except DB0 - DB7)	I <sub>OL</sub> = 0.04mA	-	-	0.2 VDD	V
R <sub>COM</sub>	Common Resistance	V <sub>LCD</sub> = 4V, I <sub>d</sub> = 0.05mA	-	2	20	KΩ
R <sub>SEG</sub>	Segment Resistance	V <sub>LCD</sub> = 4V, I <sub>d</sub> = 0.05mA	-	2	30	KΩ
I <sub>LEAK</sub>	Input Leakage Current	V <sub>IN</sub> = 0V to VDD	-1	-	1	μA
I <sub>PUP</sub>	Pull Up MOS Current	VDD = 5V	65	95	125	μA
fOSC	Oscillation frequency	VDD = 5V, 1/17duty	350	540	1100	KHz



## 2.4 Pin Definition

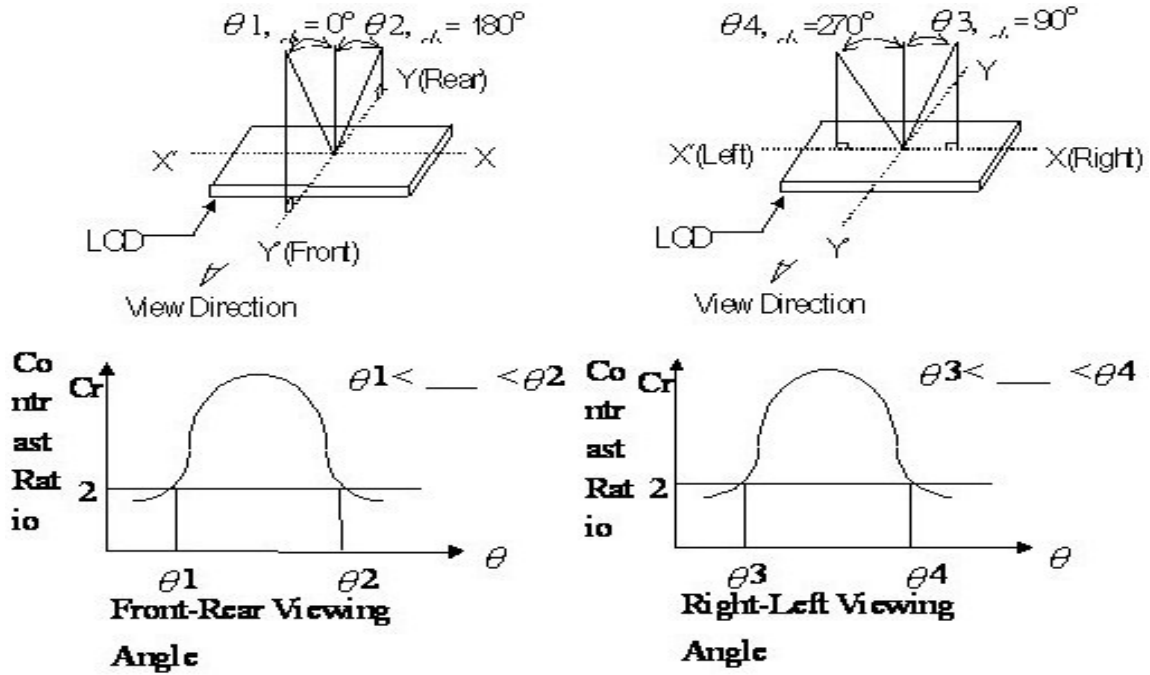
No.	Symbol	Function
1	XRESET	Reset signal input
2	DB6(SCL)	IIC Data signal input
3	DB7(SDA)	IIC Clock signal input
4	VSS	Power supply for Ground
5	VDD	Power supply for VDD
6	C1+	Voltage booster circuit
7	C1-	Voltage booster circuit
8	VOUT	DC/DC voltage converter

## 3. LED Backlight(NONE)



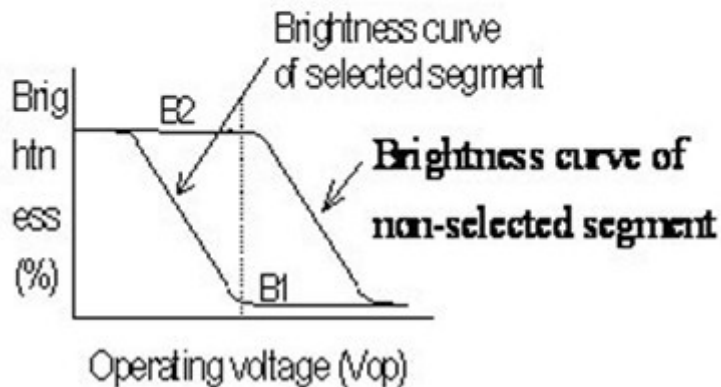
## 4. Optical Characteristics

### 4.1 Definition of Viewing Angle

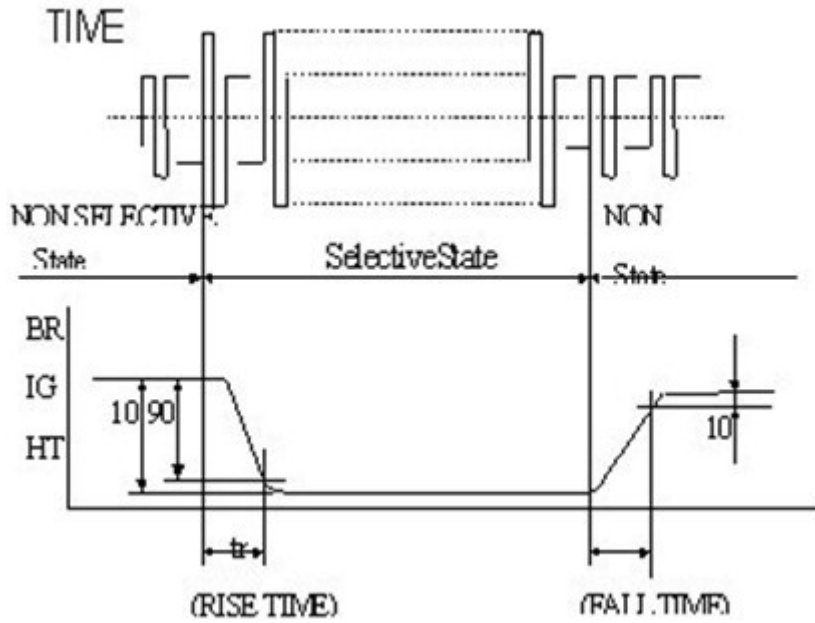


### 4.2 Definition of Contrast

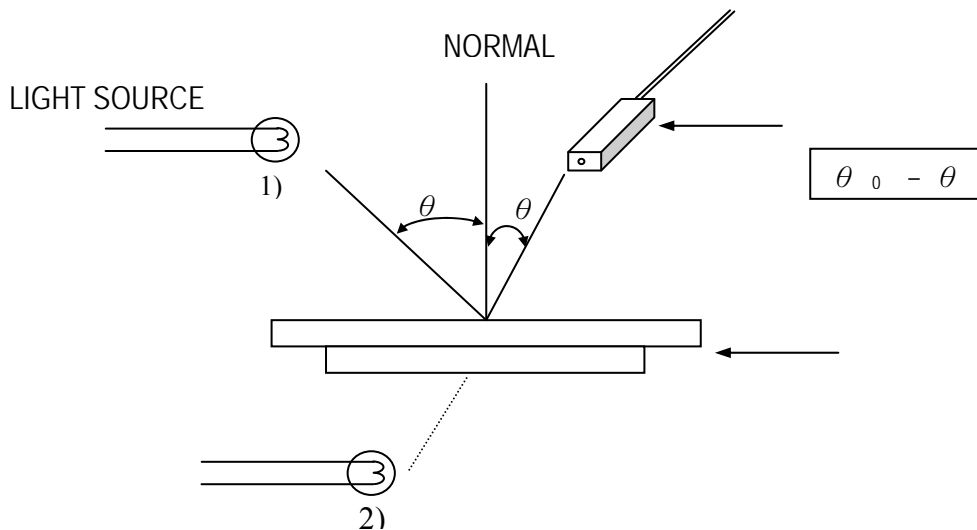
$$\text{C.R.} = \frac{\text{Brightness of nonselected segment (E2)}}{\text{Brightness of selected segment}}$$



### 4.3 Definition of Response



### 4.4 Measuring Instruments For Electro-optical Characteristics



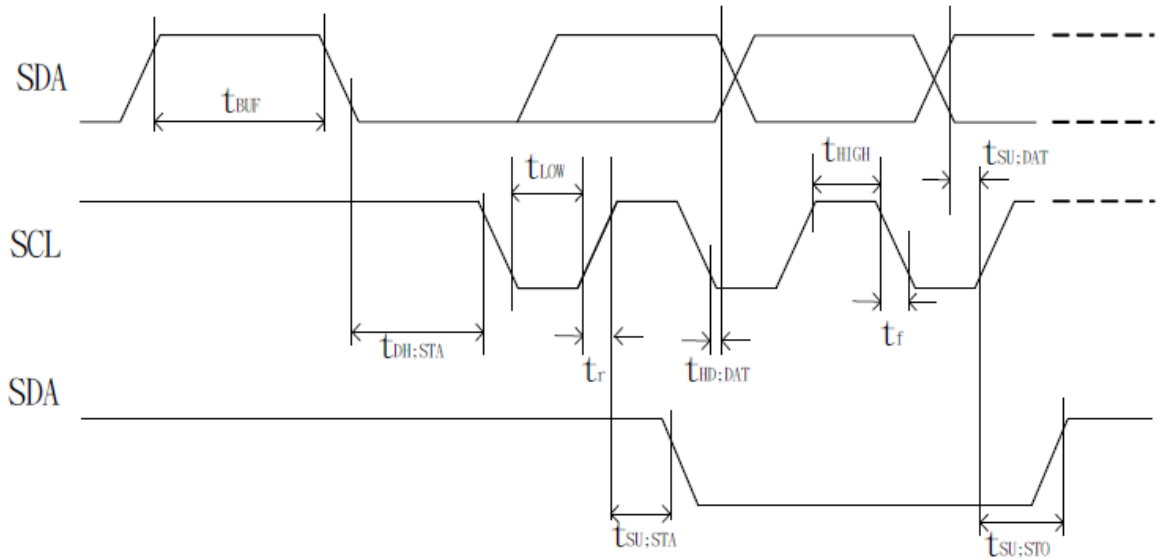
**\* Note:**

- 1) Light source position for measuring the reflective type of LCD panel;
- 2) Light source position for measuring the transfective / transmissive types of LCD panel.

## 5. AC Characteristics and Input Timing Characteristics

### 5.1 AC characteristics (Vdd=5V, Vss=0V Ta=25°C)

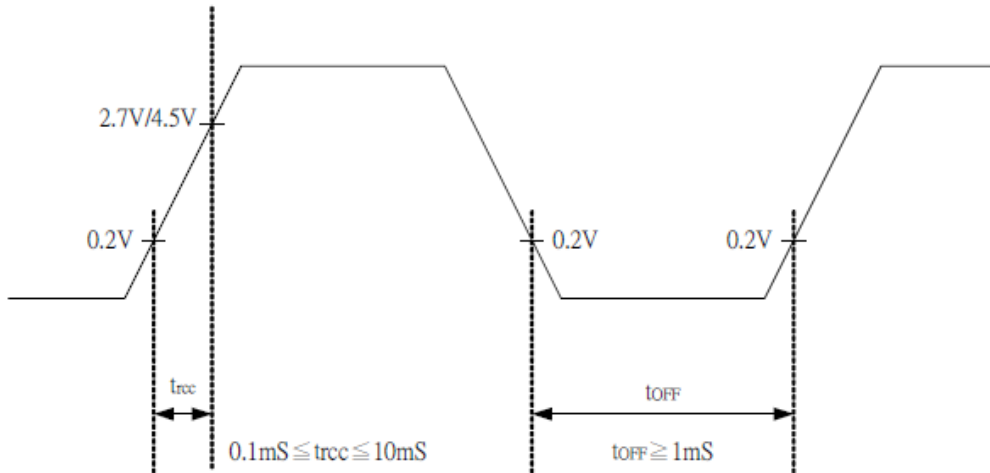
- I2C interface



( Ta =-30°C to 85°C )

Item	Signal	Symbol	Condition	VDD=2.7 to 4.5V Rating		VDD=4.5 to 5.5V Rating		Units
				Min.	Max.	Min.	Max.	
SCL clock frequency	SCL	$f_{SCLK}$	—	DC	400	DC	400	KHz
SCL clock low period		$t_{LOW}$	—	1.3	—	1.3	—	us
SCL clock high period		$t_{HIGH}$	—	0.6	—	0.6	—	us
Data set-up time	SI	$t_{SU:DAT}$	—	180	—	100	—	ns
Data hold time		$t_{HD:DAT}$	—	0	0.9	0	0.9	us
SCL,SDA rise time	SCL, SDA	$t_r$	—	$20+0.1C_b$	300	$20+0.1C_b$	300	ns
SCL,SDA fall time		$t_f$	—	$20+0.1C_b$	300	$20+0.1C_b$	300	
Capacitive load represent by each bus line		$C_b$	—	—	400	—	400	pf
Setup time for a repeated START condition	SI	$t_{SU:STA}$	—	0.6	—	0.6	—	us
Start condition hold time		$t_{HD:STA}$	—	0.6	—	0.6	—	us
Setup time for STOP condition		$t_{SU:STO}$	—	0.6	—	0.6	—	us
Bus free time between a Stop and START condition	SCL	$t_{BUF}$	—	1.3	—	1.3	—	us

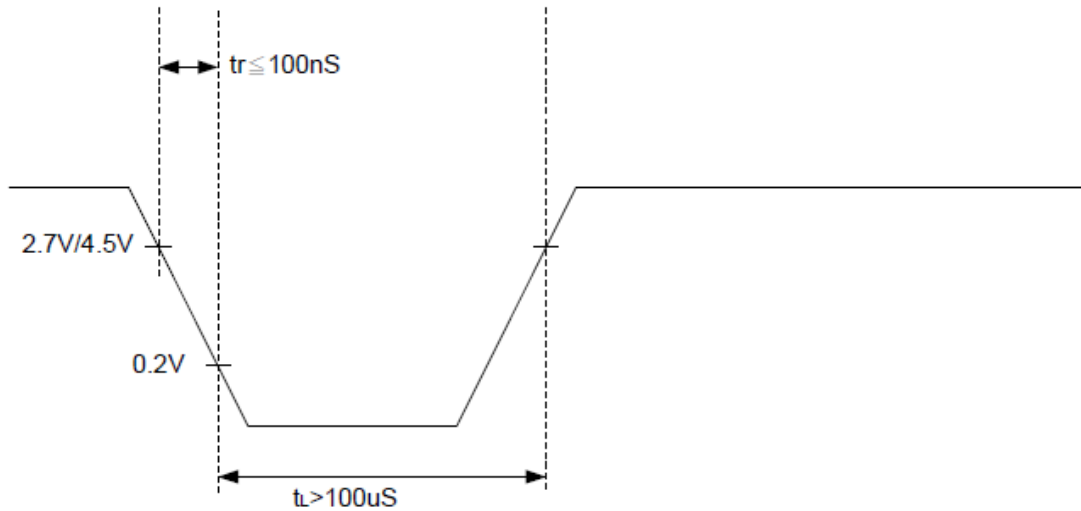
● Internal Power Supply Reset



Notes:

- $t_{OFF}$  compensates for the power oscillation period caused by momentary power supply oscillations.
- Specified at 4.5V for 5V operation, and at 2.7V for 3V operation.
- If 2.7V/4.5V is not reached during 3V/5V operation, internal reset circuit will not operate normally.

● Hardware reset(XRESET)



5.2 Write Mode(NONE)

5.3 Read Mode(NONE)



## 6. Instruction Table

➤ instruction table at “Normal mode”

(When “EXT” option pin connect to VDD, the instruction set follow below table)

Instruction	Instruction Code										Description	Instruction Execution Time			
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		OSC=380KHz	OSC=540KHz	OSC=700KHz	
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set DDRAM address to "00H" from AC	1.08 ms	0.76 ms	0.59 ms	
Return Home	0	0	0	0	0	0	0	0	0	1	x	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.08 ms	0.76 ms	0.59 ms
Entry Mode Set	0	0	0	0	0	0	0	0	1	I/D	S	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.	26.3 us	18.5 us	14.3 us
Display ON/OFF	0	0	0	0	0	0	0	1	D	C	B	D=1:entire display on C=1:cursor on B=1:cursor position on	26.3 us	18.5 us	14.3 us
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	x	x	x	S/C and R/L: Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.	26.3 us	18.5 us	14.3 us
Function Set	0	0	0	0	1	DL	N	x	x	x	DL: interface data is 8/4 bits N: number of line is 2/1	26.3 us	18.5 us	14.3 us	
Set CGRAM	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter	26.3 us	18.5 us	14.3 us	
Set DDRAM address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter	26.3 us	18.5 us	14.3 us	
Read Busy flag and address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0	0	0	
Write data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM)	26.3 us	18.5 us	14.3 us	
Read data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM)	26.3 us	18.5 us	14.3 us	

Note:

Be sure the ST7032 is not in the busy state (BF = 0) before sending an instruction from the MPU to the ST7032. If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself. Refer to Instruction Table for the list of each instruction execution time.

➤ **instruction table at “Extension mode”**  
(when “EXT” option pin connect to Vss, the instruction set follow below table)

Instruction	Instruction Code											Description	Instruction Execution Time		
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	OSC=380KHz		OSC=540kHz	OSC=700KHz	
Clear Display	0	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set DDRAM address to "00H" from AC	1.08 ms	0.76 ms	0.59 ms
Return Home	0	0	0	0	0	0	0	0	0	1	x	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.08 ms	0.76 ms	0.59 ms
Entry Mode Set	0	0	0	0	0	0	0	0	1	I/D	S	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.	26.3 us	18.5 us	14.3 us
Display ON/OFF	0	0	0	0	0	0	0	1	D	C	B	D=1:entire display on C=1:cursor on B=1:cursor position on	26.3 us	18.5 us	14.3 us
Function Set	0	0	0	0	1	DL	N	DH	*0	IS		DL: interface data is 8/4 bits N: number of line is 2/1 DH: double height font IS: instruction table select	26.3 us	18.5 us	14.3 us
Set DDRAM address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0		Set DDRAM address in address counter	26.3 us	18.5 us	14.3 us
Read Busy flag and address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0		Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0	0	0
Write data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0		Write data into internal RAM (DDRAM/CGRAM/ICONRAM)	26.3 us	18.5 us	14.3 us
Read data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0		Read data from internal RAM (DDRAM/CGRAM/ICONRAM)	26.3 us	18.5 us	14.3 us

Note \* : this bit is for test command , and must always set to “0”

Instruction table 0(IS=0)															
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	x	x		S/C and R/L: Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.	26.3 us	18.5 us	14.3 us
Set CGRAM	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0		Set CGRAM address in address counter	26.3 us	18.5 us	14.3 us

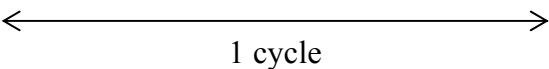
Instruction table 1(IS=1)															
Internal OSC frequency	0	0	0	0	0	1	BS	F2	F1	F0		BS=1:1/4 bias BS=0:1/5 bias F2~0: adjust internal OSC frequency for FR frequency.	26.3 us	18.5 us	14.3 us
Set ICON address	0	0	0	1	0	0	AC3	AC2	AC1	AC0		Set ICON address in address counter.	26.3 us	18.5 us	14.3 us
Power/ICON control/Contrast set	0	0	0	1	0	1	Ion	Bon	C5	C4		Ion: ICON display on/off Bon: set booster circuit on/off C5,C4: Contrast set for internal follower mode.	26.3 us	18.5 us	14.3 us
Follower control	0	0	0	1	1	0	Fon	Rab2	Rab1	Rab0		Fon: set follower circuit on/off Rab2~0: select follower amplified ratio.	26.3 us	18.5 us	14.3 us
Contrast set	0	0	0	1	1	1	C3	C2	C1	C0		Contrast set for internal follower mode.	26.3 us	18.5 us	14.3 us





## 7. Reliability Specification

### 7.1 Contents of Reliability Tests

No.	Test Item	Content of Test	Test Condition
1	High Temperature Storage	Endurance test applying the high storage temperature for a long time	+80°C 96H
2	Low Temperature Storage	Endurance test applying the low storage temperature for a long time	-30°C 96H
3	High Temperature Operation	Endurance test applying the electric stress (voltage & current) and the thermal stress to the element for a long time	+70°C 96H
4	Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time	-20°C 96H
5	High Temperature/ Humidity Storage	Endurance test applying the high temperature and humidity storage for a long time	40°C 90%RH 96H
6	Temperature Cycle	Endurance test applying the low and high temperature cycle $-20^{\circ}\text{C} \longleftrightarrow 25^{\circ}\text{C} \longleftrightarrow 70^{\circ}\text{C} \longleftrightarrow 25^{\circ}\text{C}$ 30min      5min      30min      5min  1 cycle	-20°C/70°C 10 cycles
7	Vibration Test (Package State)	Endurance test applying the vibration during transportation	10Hz—55Hz, 50m/s,15min
8	Shock Test (Package State)	Endurance test applying the shock during transportation	Half-sinewave, 100m/s, 11ms
9	Atmospheric Pressure Test	Endurance test applying the atmospheric pressure during transportation by air	40 kPa 16 H

### 7.2 Life Time

Item	Description
1	Function, performance, appearance, etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions of room temperature (25±10°C), normal humidity (45±20% RH), and in area not exposed to direct sunlight.

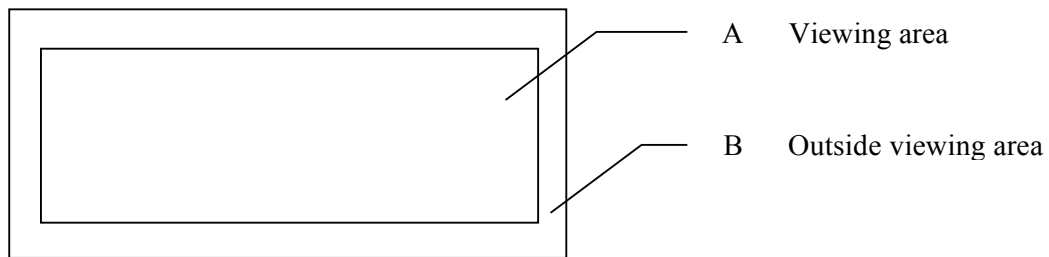
**\* Note: Test Condition**

- 1) Temperature and humidity: If no specification, Temperature set at 25±2°C, Humidity set at 60±5%RH;
- 2) Operating state: Samples subject to the tests shall be in “ Operating ” condition.



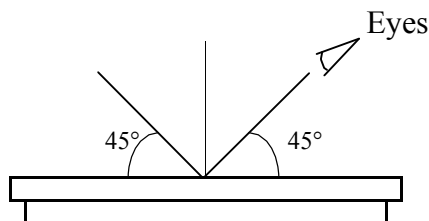
## 8. Quality Level

### 8.1 Zone Definition


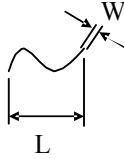
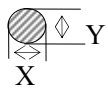
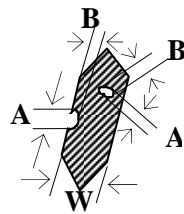
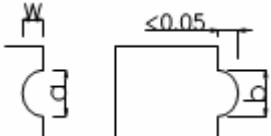


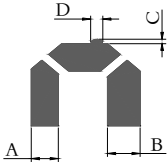
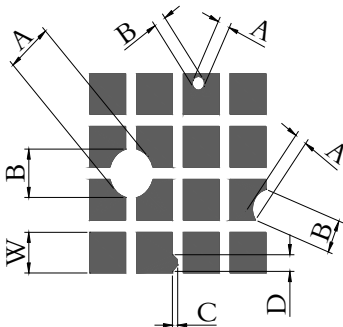
### 8.2 Visual Inspection

- 1) Inspect under 2x20W or 40W fluorescent lamp (approximately 3000 lux) leaving 25 to 30 cm between the module and the lamp and 30 cm between the module and the eye (measuring position).
- 2) Appearance is inspected at the best contrast voltage (best contrast is adjusted considering clearness and crosstalk on screen).
- 3) Inspect the module at 45° right and left, top and bottom.
- 4) Use the optimum viewing angle during the contrast inspection.



**8.3 Standard of Appearance Inspection**

No.	Item	Criteria																																			
1	Black spot White spot Dust	<p>Round type: as per following drawing  <math>\Phi = (X+Y)/2</math></p>  <table border="1"> <thead> <tr> <th colspan="3">Acceptable quantity</th> </tr> <tr> <th>Size</th> <th>Zone A</th> <th>Zone B</th> </tr> </thead> <tbody> <tr> <td><math>\Phi &lt; 0.1</math></td> <td>Any number</td> <td rowspan="4">Any number</td> </tr> <tr> <td><math>0.1 &lt; \Phi &lt; 0.2</math></td> <td>2</td> </tr> <tr> <td><math>0.2 &lt; \Phi &lt; 0.25</math></td> <td>1</td> </tr> <tr> <td><math>0.25 &lt; \Phi</math></td> <td>0</td> </tr> </tbody> </table> <p>Line type: as per following drawing</p>  <table border="1"> <thead> <tr> <th colspan="4">Acceptable quantity</th> </tr> <tr> <th>Length</th> <th>Width</th> <th>Zone A</th> <th>Zone B</th> </tr> </thead> <tbody> <tr> <td>—</td> <td><math>W \leq 0.02</math></td> <td>Any number</td> <td rowspan="4">Any number</td> </tr> <tr> <td><math>L \leq 3.0</math></td> <td><math>0.02 &lt; W \leq 0.03</math></td> <td rowspan="2">2</td> </tr> <tr> <td><math>L \leq 2.5</math></td> <td><math>0.03 &lt; W \leq 0.05</math></td> </tr> <tr> <td>—</td> <td><math>0.05 &lt; W</math></td> <td>As round type</td> </tr> </tbody> </table> <p>Total acceptable quantity: 3</p>	Acceptable quantity			Size	Zone A	Zone B	$\Phi < 0.1$	Any number	Any number	$0.1 < \Phi < 0.2$	2	$0.2 < \Phi < 0.25$	1	$0.25 < \Phi$	0	Acceptable quantity				Length	Width	Zone A	Zone B	—	$W \leq 0.02$	Any number	Any number	$L \leq 3.0$	$0.02 < W \leq 0.03$	2	$L \leq 2.5$	$0.03 < W \leq 0.05$	—	$0.05 < W$	As round type
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$L \leq 2.5$	$0.03 < W \leq 0.05$																																				
—	$0.05 < W$	As round type																																			
2	Polariser scratch	<p>Scratch on protective film is permitted  Scratch on polariser: same as No. 1</p>																																			
3	Polariser bubble	<p><math>\Phi = (X+Y)/2</math></p>  <table border="1"> <thead> <tr> <th colspan="3">Acceptable quantity</th> </tr> <tr> <th>Size</th> <th>Zone A</th> <th>Zone B</th> </tr> </thead> <tbody> <tr> <td><math>\Phi &lt; 0.2</math></td> <td>Any number</td> <td rowspan="4">Any number</td> </tr> <tr> <td><math>0.2 &lt; \Phi &lt; 0.5</math></td> <td>2</td> </tr> <tr> <td><math>0.5 &lt; \Phi &lt; 1.0</math></td> <td>1</td> </tr> <tr> <td><math>1.0 &lt; \Phi</math></td> <td>0</td> </tr> </tbody> </table> <p>Total acceptable quantity: 3</p>	Acceptable quantity			Size	Zone A	Zone B	$\Phi < 0.2$	Any number	Any number	$0.2 < \Phi < 0.5$	2	$0.5 < \Phi < 1.0$	1	$1.0 < \Phi$	0																				
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$0.5 < \Phi < 1.0$	1																																				
$1.0 < \Phi$	0																																				
4	Segment deformation	<p>4.1 Pin hole on segmented display  W: segment width  <math>\Phi = (A+B)/2</math></p>  <table border="1"> <thead> <tr> <th colspan="2">Acceptable quantity</th> </tr> <tr> <th>Width</th> <th>Quantity</th> </tr> </thead> <tbody> <tr> <td><math>W \leq 0.4</math></td> <td><math>\Phi \leq 0.2</math> and <math>\Phi \leq 1/2W</math></td> </tr> <tr> <td><math>W &gt; 0.4</math></td> <td><math>\Phi \leq 0.25</math> and <math>\Phi \leq 1/3W</math></td> </tr> </tbody> </table> <p>Total acceptable quantity: 1 defect per segment  Pin holes with <math>\Phi</math> under 0.10 mm are acceptable</p> <p>4.2 Pin hole on dot matrix display</p>  <table border="1"> <thead> <tr> <th colspan="2">Acceptable quantity</th> </tr> <tr> <th>Size</th> <th>Quantity</th> </tr> </thead> <tbody> <tr> <td>a, b &lt; 0.1</td> <td>Any number</td> </tr> <tr> <td><math>(a+b)/2 \leq 0.1</math></td> <td>Any number</td> </tr> <tr> <td><math>0.5 &lt; \Phi &lt; 1.0</math></td> <td>3</td> </tr> </tbody> </table> <p>Total acceptable quantity: 7</p> <p>4.3 Segments / dots with different width</p>	Acceptable quantity		Width	Quantity	$W \leq 0.4$	$\Phi \leq 0.2$ and $\Phi \leq 1/2W$	$W > 0.4$	$\Phi \leq 0.25$ and $\Phi \leq 1/3W$	Acceptable quantity		Size	Quantity	a, b < 0.1	Any number	$(a+b)/2 \leq 0.1$	Any number	$0.5 < \Phi < 1.0$	3																	
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$(a+b)/2 \leq 0.1$	Any number																																				
$0.5 < \Phi < 1.0$	3																																				

		 <table border="1" data-bbox="938 241 1289 340"> <thead> <tr> <th colspan="2">Acceptable</th> </tr> </thead> <tbody> <tr> <td><math>a \geq b</math></td> <td><math>a/b \leq 4/3</math></td> </tr> <tr> <td><math>a &lt; b</math></td> <td><math>a/b &gt; 4/3</math></td> </tr> </tbody> </table> <p>4.4 Alignment layer defect  <math>\Phi = (A+B)/2</math></p>  <table border="1" data-bbox="944 548 1295 766"> <thead> <tr> <th colspan="2">Acceptable quantity</th> </tr> <tr> <th>Size</th> <th></th> </tr> </thead> <tbody> <tr> <td><math>\Phi \leq 0.4</math></td> <td>Any number</td> </tr> <tr> <td><math>0.4 &lt; \Phi \leq 1.0</math></td> <td>5</td> </tr> <tr> <td><math>1.0 &lt; \Phi \leq 1.5</math></td> <td>3</td> </tr> <tr> <td><math>1.5 &lt; \Phi \leq 2.0</math></td> <td>2</td> </tr> </tbody> </table> <p>Total acceptable quantity: 7</p>	Acceptable		$a \geq b$	$a/b \leq 4/3$	$a < b$	$a/b > 4/3$	Acceptable quantity		Size		$\Phi \leq 0.4$	Any number	$0.4 < \Phi \leq 1.0$	5	$1.0 < \Phi \leq 1.5$	3	$1.5 < \Phi \leq 2.0$	2
Acceptable																				
$a \geq b$	$a/b \leq 4/3$																			
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$1.0 < \Phi \leq 1.5$	3																			
$1.5 < \Phi \leq 2.0$	2																			
5	Colour uniformity	Level of sample for approval set as limit sample																		
6	Backlight	The backlight colour should correspond to the product specification Flashing and or unlit backlight is not allowed Dust larger than 0.25 mm is not allowed																		
7	COB	Exposed wire bond pad is not allowed Insufficient covering with resin is not allowed (wire bond line exposed) Dust or bubble on the resin are not allowed																		
8	PCB	No unmelted solder paste should be present on PCB Cold solder joints, missing solder connections, or oxidation are not allowed No residue or solder balls on PCB are allowed Short circuits on components are not allowed																		
9	Tray particles	<table border="1" data-bbox="686 1317 1212 1523"> <thead> <tr> <th colspan="3">Acceptable quantity</th> </tr> <tr> <th></th> <th>Size</th> <th>Quantity</th> </tr> </thead> <tbody> <tr> <td rowspan="2">On tray</td> <td><math>\Phi &lt; 0.2</math></td> <td>Any number</td> </tr> <tr> <td><math>\Phi &gt; 0.25</math></td> <td>4</td> </tr> <tr> <td rowspan="2">On display</td> <td><math>\Phi \geq 0.25</math></td> <td>2</td> </tr> <tr> <td><math>L = 3</math></td> <td>1</td> </tr> </tbody> </table>	Acceptable quantity				Size	Quantity	On tray	$\Phi < 0.2$	Any number	$\Phi > 0.25$	4	On display	$\Phi \geq 0.25$	2	$L = 3$	1		
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	$L = 3$	1																		

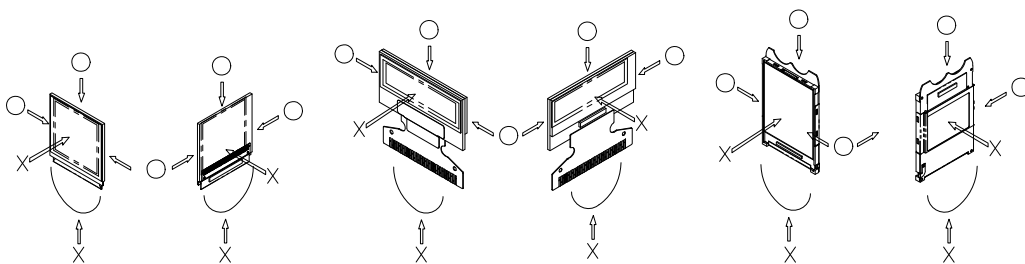
## 9. Package Specifications

T.B.D.

## 10. Precautions When Using These LCD Modules

### 10.1 Handling Precautions

- 1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- 2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- 3) If pressure is applied to the display surface or its neighborhood of the LCD Module, the cell structure may be damaged and be careful not to apply pressure to these sections.
- 4) The polarizer covering the surface of the LCD Module is soft and easily scratched. Please be careful when handling the LCD Module.
- 5) When the surface of the polarizer of the LCD Module has soil, clean the surface. It takes dvantage of by using following adhesion tape.
  - \* Scotch Mending Tape No. 810 or an equivalent.Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.  
Also, pay attention that the following liquid and solvent may spoil the polarizer:
  - \* Water
  - \* Ketone
  - \* Aromatic Solvents
- 6) Hold LCD Module very carefully when palcing LCD Module into the system housing. Do not apply excessive stress or pressure to LCD Module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- 7) Do not apply stress to the LSI chips and the surrounding molded sections.
- 8) Do not disassemble nor modify the LCD Module.
- 9) Do not apply input signals while the logic power is off.
- 10) Pay sufficient attention to the working environments when handing LCD Modules to prevent occurrence of element breakage accidents by static electricity.
  - \* Be sure to make human body grounding when handling LCD Modules.
  - \* Be sure to ground tools to use or assembly such as soldering irons.
  - \* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
  - \* Protective film is being applied to the surface of the display panel of the LCD Module. Be careful since static electricity may be generated when exfoliating the

protective film.

- \* Protective film is being applied to the surface of the display panel of the LCD Module. Be careful since static electricity may be generated when exfoliating the protective film
- 11) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the LCD Module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5).
- 12) If electric current is applied when the LCD Module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above.

## 10.2 Storage Precautions

- 1) When storing LCD Modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps. and, also, avoiding high temperature and high humidity environment or low temperature (less than 0°C) environments. (We recommend you to store these modules in the packaged state when they were shipped from Blaze Display Technology Co., Ltd.)  
At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them.
- 2) If electric current is applied when water drops are adhering to the surface of the LCD Module, when the LCD Module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above.

## 10.3 Designing Precautions

- 1) The absolute maximum ratings are the ratings which can not be exceeded for LCD Module, and if these values are exceeded, panel damage may be happen.
- 2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
- 3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)
- 5) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.
- 6) As for EMI, take necessary measures on the equipment side basically.  
When fastening the LCD Module, fasten the external plastic housing section.
- 7) If power supply to the LCD Module is forcibly shut down by such errors as taking out the main battery while the LCD Panel is in operation, we cannot guarantee the quality of this LCD Module.
- 8) The electric potential to be connected to the rear face of the IC chip should be as follows:
  - \* Connection (contact) to any other potential than the above may lead to rupture of the IC.



#### 10.4 Precautions When Disposing of the LCD Modules

Request the qualified companies to handle industrial wastes when disposing of the LCD Modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

#### 10.5 Other Precautions

- 1) When a LCD Module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.  
Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module
- 2) To protect LCD Modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the LCD Modules.
  - \* Pins and electrodes
  - \* Pattern layouts such as the TCP & FPC
- 3) With this LCD Module, the LCD Module driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this LCD Module driver is exposed to light, malfunctioning may occur.
  - \* Design the product and installation method so that the LCD Module driver may be shielded from light in actual usage.
  - \* Design the product and installation method so that the LCD Module driver may be shielded from light during the inspection processes.
- 4) Although this LCD Module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- 5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.